

To our customers,

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## Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: <http://www.renesas.com>

April 1<sup>st</sup>, 2010  
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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Phase-out/Discontinued

NPN SILICON EPITAXIAL TRANSISTOR (DARLINGTON CONNECTION)  
FOR HIGH-SPEED SWITCHING

The 2SC4351 is a high-speed Darlington power transistor. This transistor is ideal for high-precision control such as PWM control for pulse motors or brushless motor of OA and FA equipment.

FEATURES

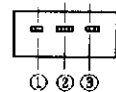
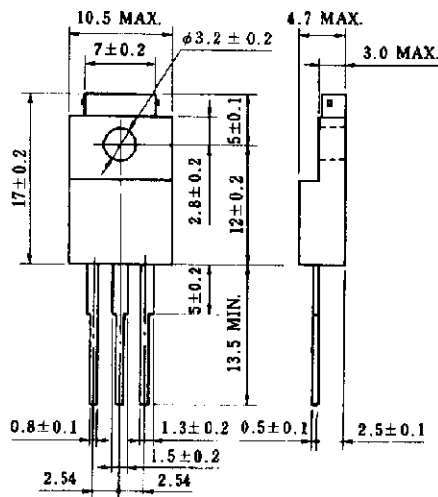
- Mold package that does not require an insulating board or insulation bushing
- On-chip C to B constant voltage diode for surge voltage absorption
- On-chip C to E reverse diode
- Fast switching speed

ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

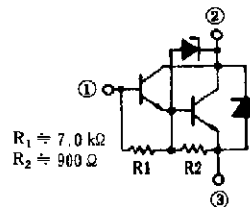
| Parameter                    | Symbol                     | Ratings     | Unit |
|------------------------------|----------------------------|-------------|------|
| Collector to base voltage    | V <sub>CBO</sub>           | 60 ± 10     | V    |
| Collector to emitter voltage | V <sub>CEO</sub>           | 60 ± 10     | V    |
| Emitter to base voltage      | V <sub>EBO</sub>           | 8.0         | V    |
| Collector current (DC)       | I <sub>C(DC)</sub>         | ±5.0        | A    |
| Collector current (pulse)    | I <sub>C(pulse)*</sub>     | ±10         | A    |
| Base current (DC)            | I <sub>B(DC)</sub>         | 0.5         | A    |
| Total power dissipation      | P <sub>T</sub> (Tc = 25°C) | 20          | W    |
| Total power dissipation      | P <sub>T</sub> (Ta = 25°C) | 2.0         | W    |
| Junction temperature         | T <sub>J</sub>             | 150         | °C   |
| Storage temperature          | T <sub>stg</sub>           | -55 to +150 | °C   |

\* PW ≤ 10 ms, duty cycle ≤ 50%

PACKAGE DRAWING (UNIT: mm)



Electrode Connection  
1. Base  
2. Collector  
3. Emitter



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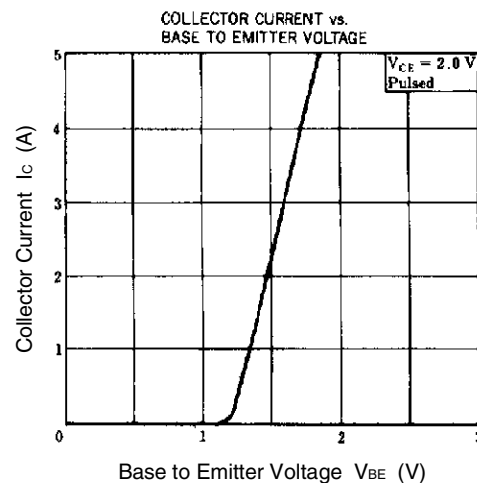
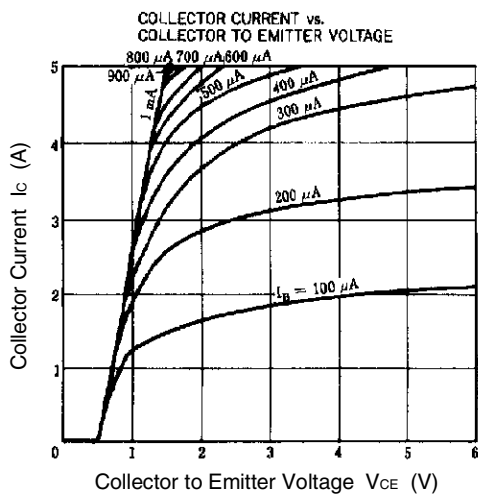
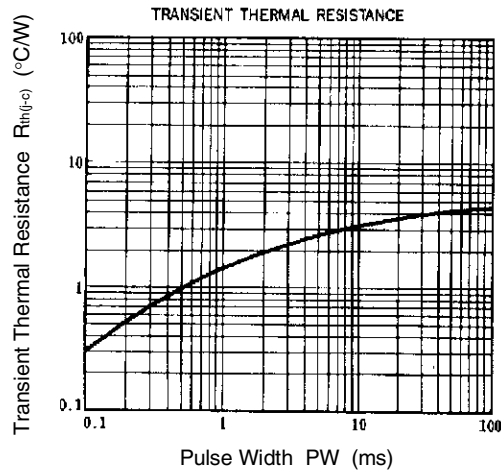
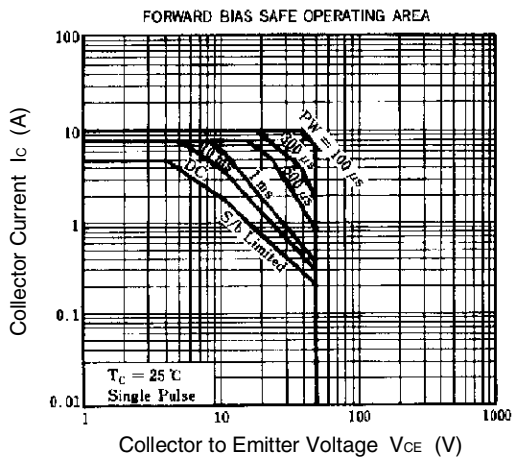
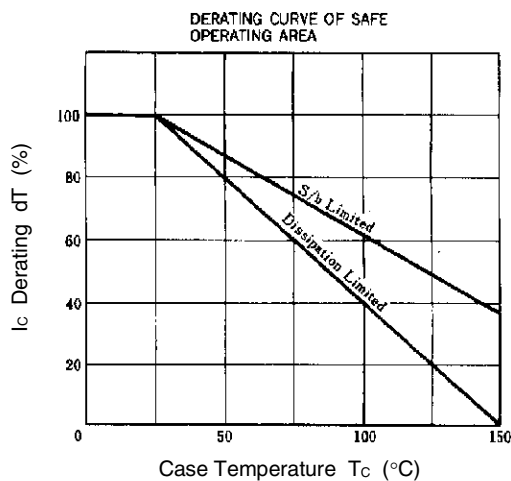
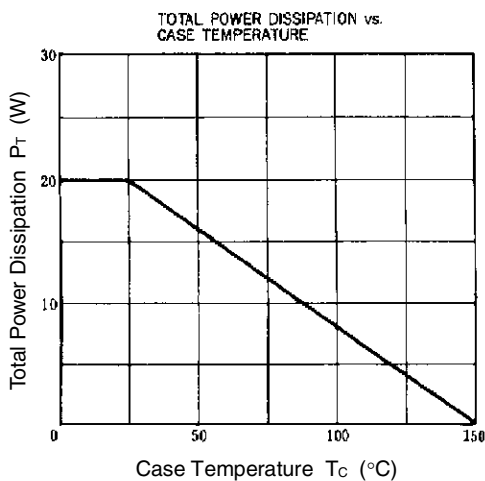
| Parameter                    | Symbol          | Conditions  | MIN.  | TYP. | MAX.   | Unit          |
|------------------------------|-----------------|---|-------|------|--------|---------------|
| Collector cutoff current     | $I_{CBO}$       | $V_{CB} = 40\text{ V}, I_E = 0$   |       |      | 0.5    | $\mu\text{A}$ |
| DC current gain              | $h_{FE1}^*$     | $V_{CE} = 2.0\text{ V}, I_C = 2.0\text{ A}$   | 2,000 |      | 20,000 |               |
| DC current gain              | $h_{FE2}^*$     | $V_{CE} = 2.0\text{ V}, I_C = 4.0\text{ A}$   | 500   |      |        |               |
| Collector saturation voltage | $V_{CE(sat)}^*$ | $I_C = 2.0\text{ A}, I_B = 2.0\text{ mA}$   |       |      | 1.5    | V             |
| Base saturation voltage      | $V_{BE(sat)}^*$ | $I_C = 2.0\text{ A}, I_B = 2.0\text{ mA}$   |       |      | 2.0    | V             |
| Turn-on time                 | $t_{on}$        | $I_C = 2.0\text{ A}, I_{B1} = -I_{B2} = 2.0\text{ mA},$<br>$R_L = 25\ \Omega, V_{CC} \cong 50\text{ V}$<br>Refer to the test circuit. |       | 0.7  |        | $\mu\text{s}$ |
| Storage time                 | $t_{stg}$       |   |       | 2.5  |        | $\mu\text{s}$ |
| Fall time                    | $t_f$           |   |       | 0.6  |        | $\mu\text{s}$ |

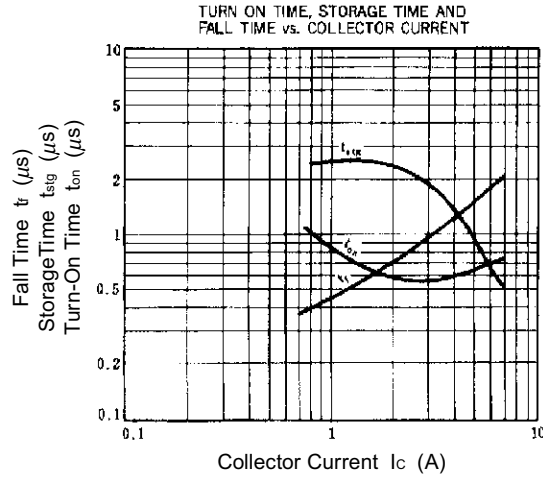
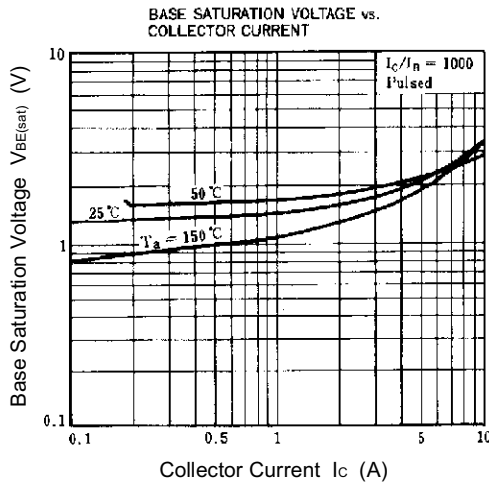
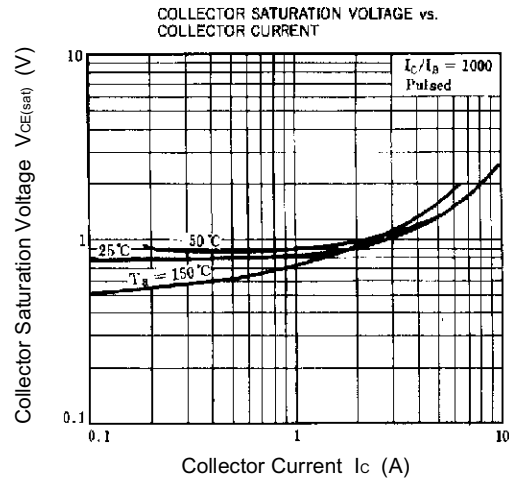
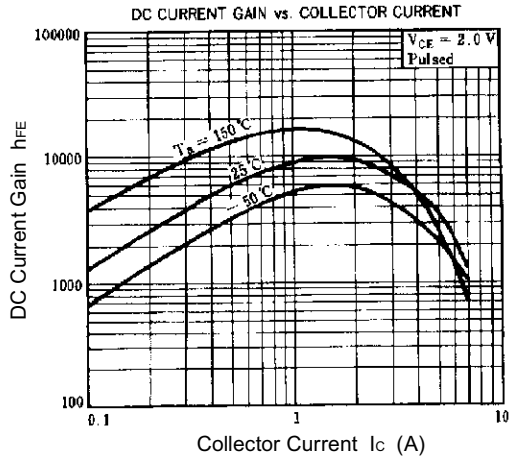
\* Pulse test  $PW \leq 350\ \mu\text{s}$ , duty cycle  $\leq 2\%$

**$h_{FE}$  CLASSIFICATION**

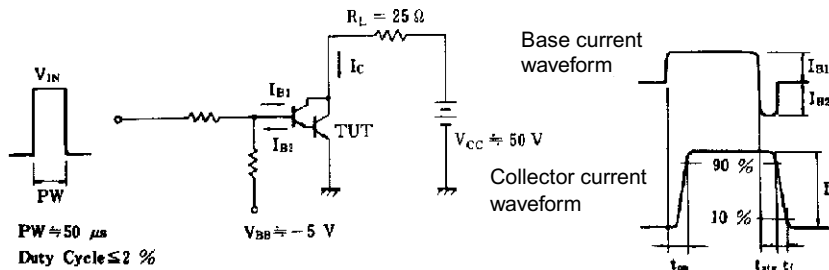
| Marking   | M              | L               | K               |
|-----------|----------------|-----------------|-----------------|
| $h_{FE1}$ | 2,000 to 5,000 | 4,000 to 10,000 | 8,000 to 20,000 |

TYPICAL CHARACTERISTICS (Ta = 25°C)





**SWITCHING TIME ( $t_{on}$ ,  $t_{stg}$ ,  $t_f$ ) TEST CIRCUIT**



[MEMO]

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